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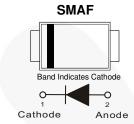


August 2015

# FSV330AF / FSV340AF Schottky Barrier Rectifier

### **Features**

- Low Forward Voltage Drop: 0.5 V Maximum at 3 A, T<sub>A</sub> = 25°
- Ultra Thin Profile Maximum Height of 1.0 mm
- · High Surge Capacity
- · UL Flammability 94V-0 Classification
- MSL
- · RoHS Compliant / Green Mold Compound



### **Ordering Information**

| Part Number | Top Mark | Package         | Packing Method |
|-------------|----------|-----------------|----------------|
| FSV330AF    | FSV330AF | DO-214AD (SMAF) | Tape and Reel  |
| FSV340AF    | FSV340AF | DO-214AD (SMAF) | Tape and Reel  |

### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25^{\circ}\text{C}$  unless otherwise noted.

| Symbol             | Parameter  | Va       | Unit     |       |
|--------------------|--|----------|----------|-------|
|                    | r ai ailietei  | FSV330AF | FSV340AF | Oilit |
| V <sub>RRM</sub>   | Recurrent Peak Reverse Voltage   | 30       | 40       | V     |
| V <sub>RMS</sub>   | RMS Reverse Voltage  | 21 28    |          | V     |
| V <sub>R</sub>     | DC Blocking Voltage  | 30 40    |          | V     |
| I <sub>F(AV)</sub> | Average Forward Current  | 3        |          | Α     |
| I <sub>FSM</sub>   | Peak Forward Surge Current: 8.3 ms Single Half Sine-Wave Superimposed on Rated Load (JEDEC Method)  80 |          | 0        | Α     |
| TJ                 | Operating Junction Temperature Range -55 to +150   |          | +150     | °C    |
| T <sub>STG</sub>   | Storage Temperature Range -55 to +150  |          | +150     | °C    |

### **Thermal Characteristics**

Values are at  $T_A = 25$ °C unless otherwise noted.

| Symbol          | Parameter  | Value | Unit |
|-----------------|--|-------|------|
| ΨJL             | Typical Thermal Characteristics, Junction-to-Lead <sup>(1)</sup> | 20    | °C/W |
| $R_{\theta JA}$ | Typical Thermal Resistance, Junction-to-Ambient <sup>(2)</sup>   | 150   | °C/W |

### Notes:

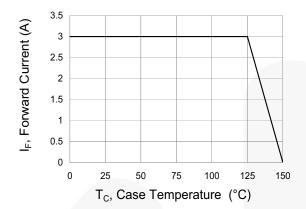
- 1. Mounted on FR4 PCB, single-sided copper, with 48cm<sup>2</sup> copper pad area.
- 2. Mounted on FR4 PCB, single-sided copper, mini pad.

### **Electrical Characteristics**

Values are at  $T_A = 25$ °C unless otherwise noted.

| Symbol                 | Parameter              | Condition  | ıs       | Min. | Тур.  | Max. | Unit |
|------------------------|------------------------|--|----------|------|-------|------|------|
| $V_{F}$                | Forward Voltage        | I <sub>F</sub> = 3 A   |          |      |       | 0.5  | V    |
| I <sub>R</sub>         | Reverse Current        | $V_R = V_{DC}, T_A = 85^{\circ}C$                                      |          |      |       | 100  | μΑ   |
| T <sub>rr</sub> Revers | Reverse Recovery Time  | $I_F = 0.5 \text{ A}, I_R = 1 \text{ A},$<br>$I_{rr} = 0.25 \text{ A}$ | FSV330AF |      | 12.50 |      | nc   |
|                        | neverse necovery fille | $I_{rr} = 0.25 A$  | FSV340AF |      | 12.62 |      | ns   |
| CJ                     | Junction Capacitance   | $V_R = 0 V, f = 1 MHz$   |          |      | 485   |      | pF   |

### **Typical Performance Characteristics**



**Figure 1. Forward Current Derating Curve** 

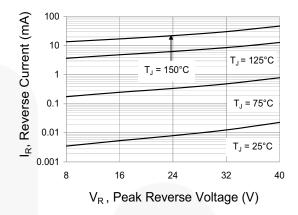


Figure 2. Typical Reverse Characteristics

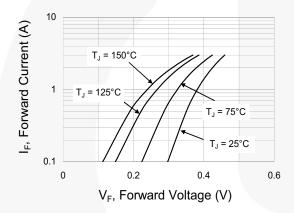


Figure 3. Typical Forward Characteristics

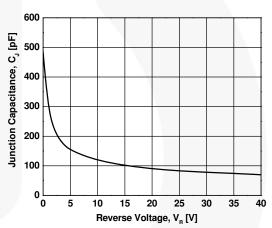
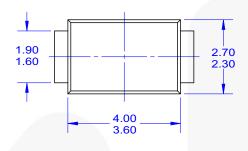
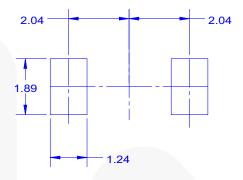


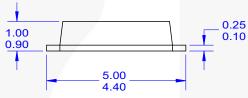
Figure 4. Typical Junction Capacitance

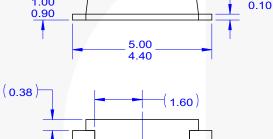
### **Physical Dimensions**



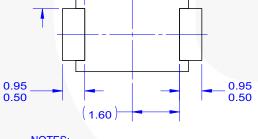


LAND PATTERN RECOMMENDATION









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  D. LAND PATTERN RECOMMENDATION PER IPC SODFL4725X110N
  E. DRAWING FILE NAME: MKT-DO214AD REV2

Figure 5. 2-LEAD, SMAF, NON JEDEC FLAT LEAD





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